

Modeling of pound cake baking behavior in continuous flow

Presented by:
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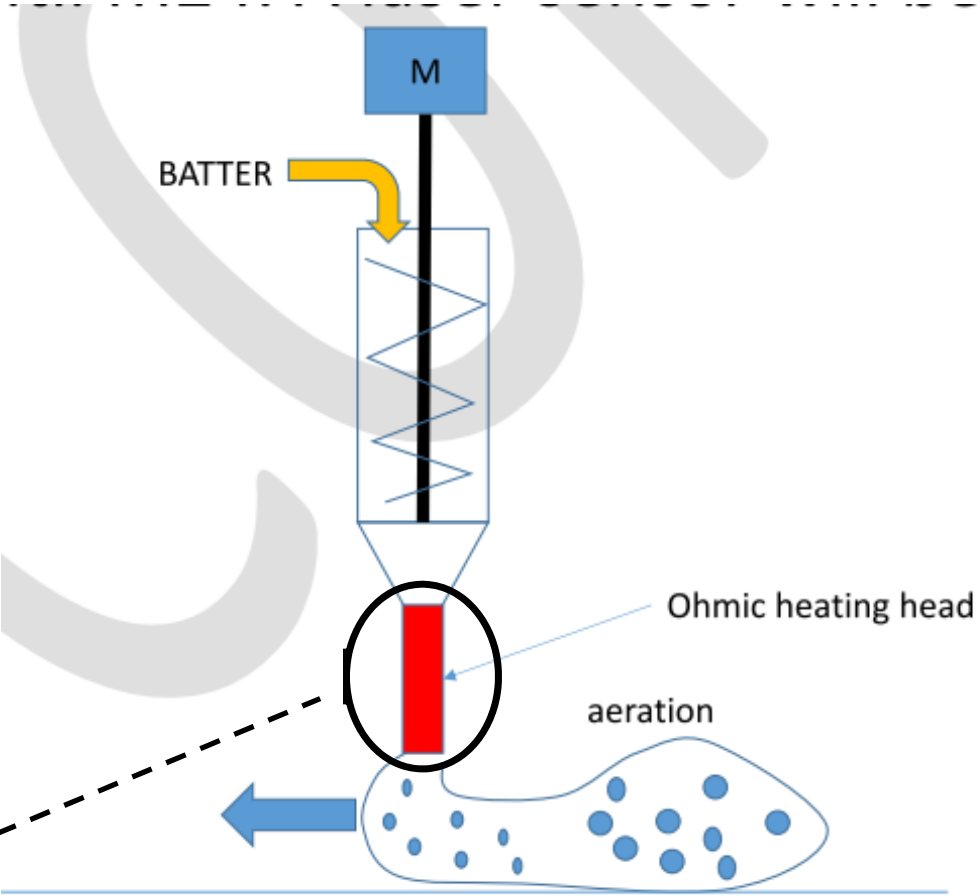
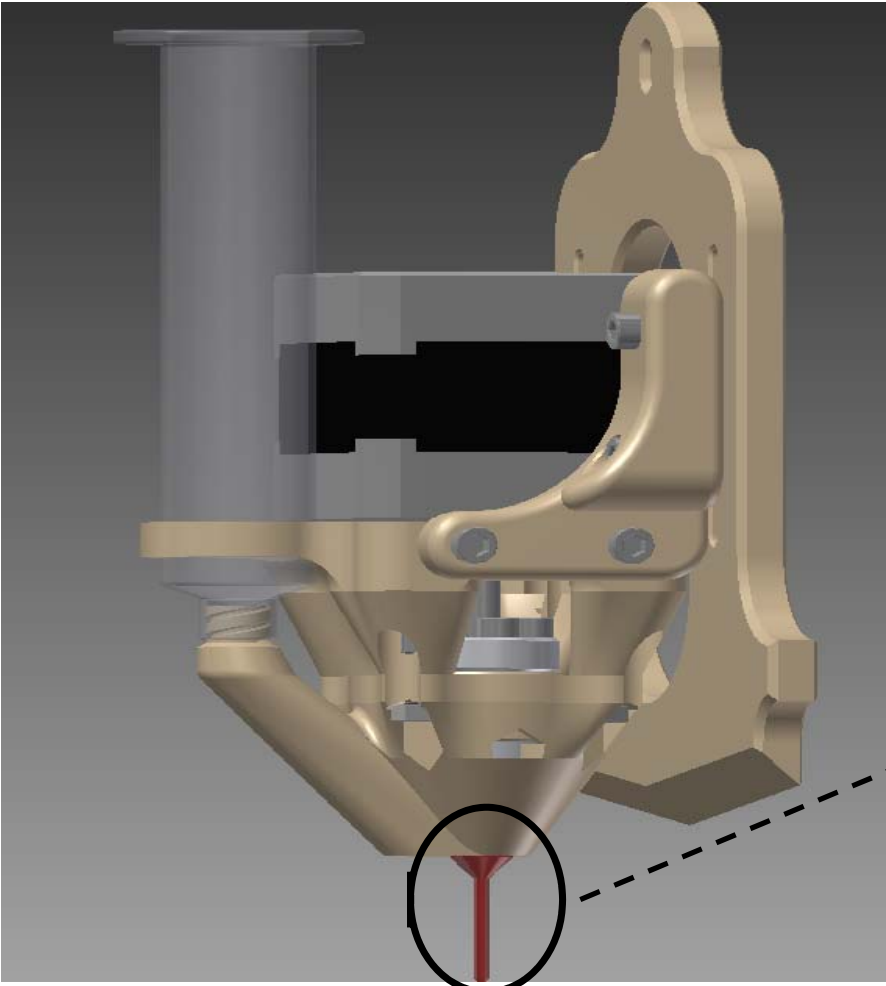
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Advisor: LE BAIL Patricia (INRA - Nantes)

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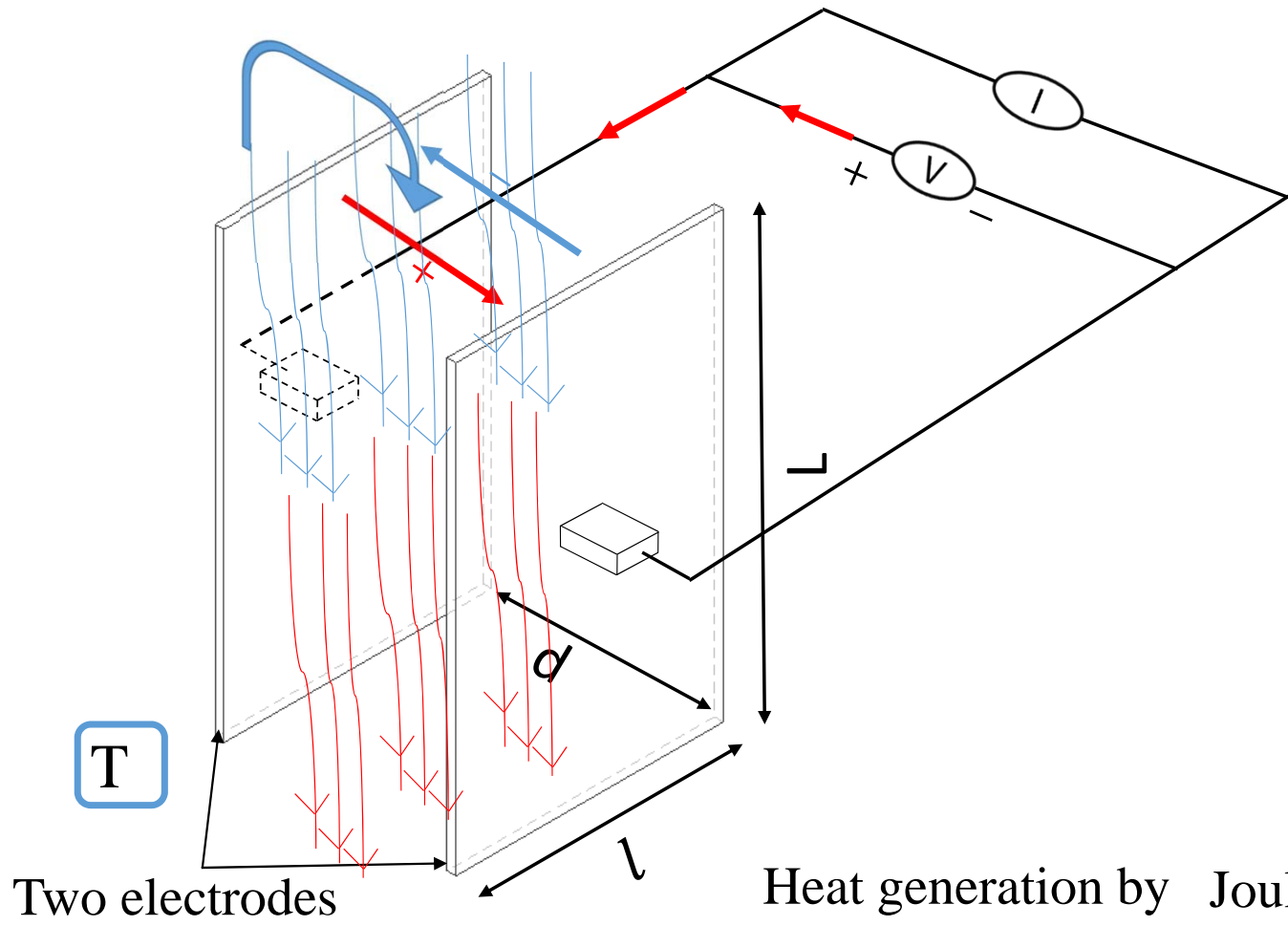
Date and place: 23-10-2018 Lausanne-Switzerland

3D Printer Head



What is OH ?

Fluid flow



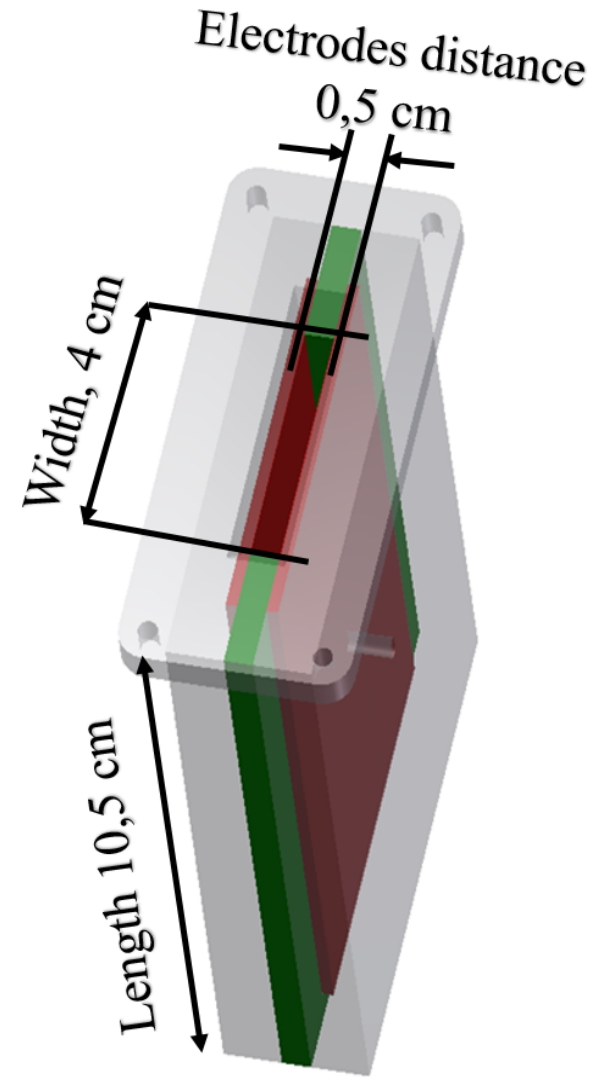
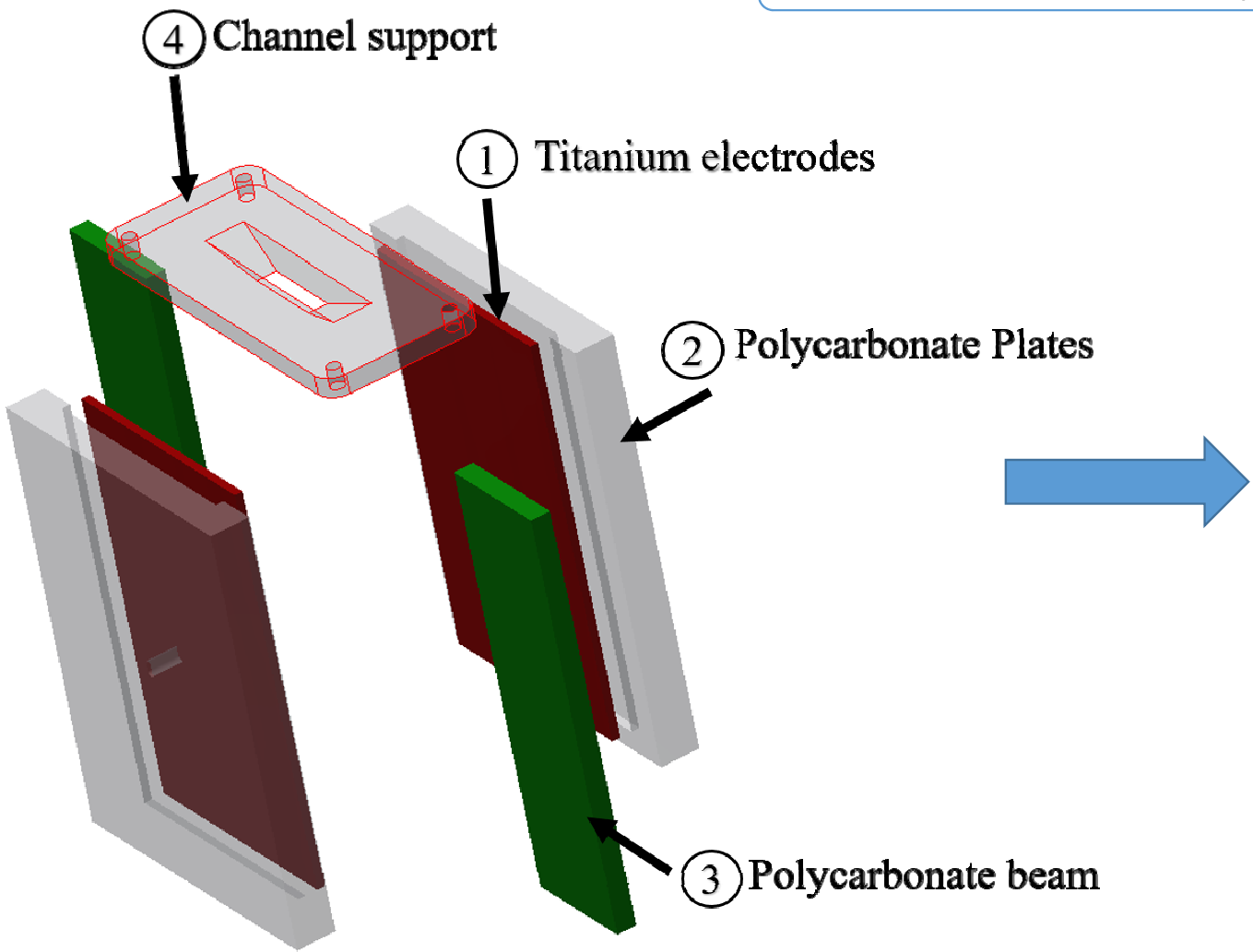
Input:
 Constant Voltage V
 Variable Current I

$S_{electrodes} = L * l$
 Field strength: $E = \frac{V}{d}$

Electrical conductivity: σ

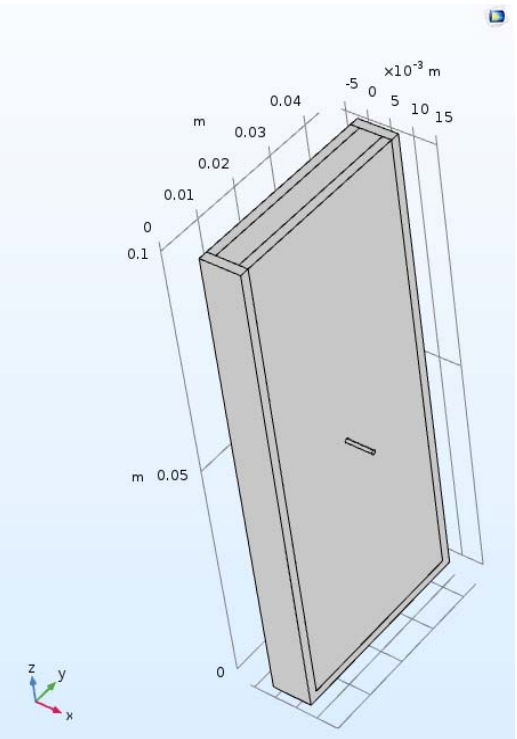
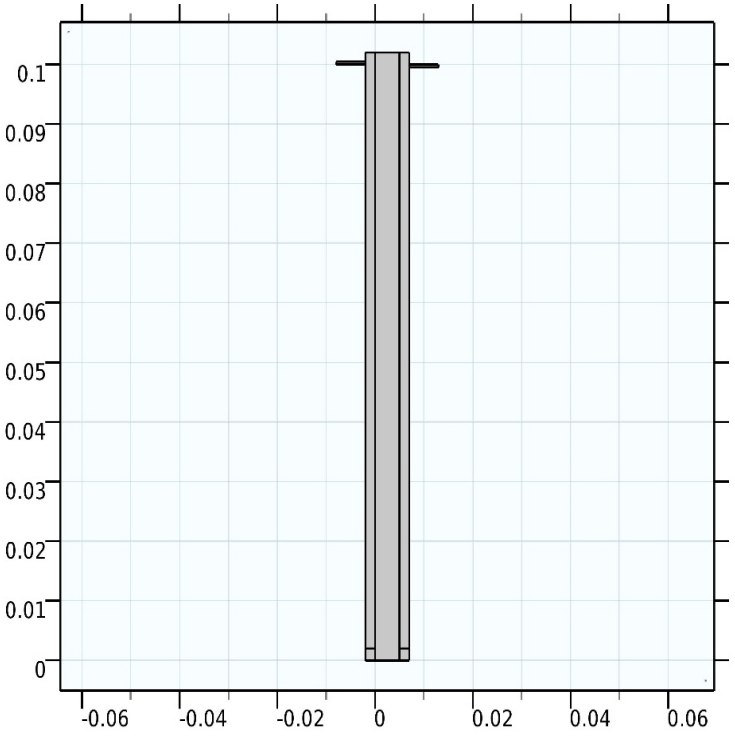
$$\dot{Q} = \sigma |E|^2$$

Nozzle Geometry



COMSOL Geometry and Physics ?

2D and 3D models were plotted on COMSOL 5,3a.

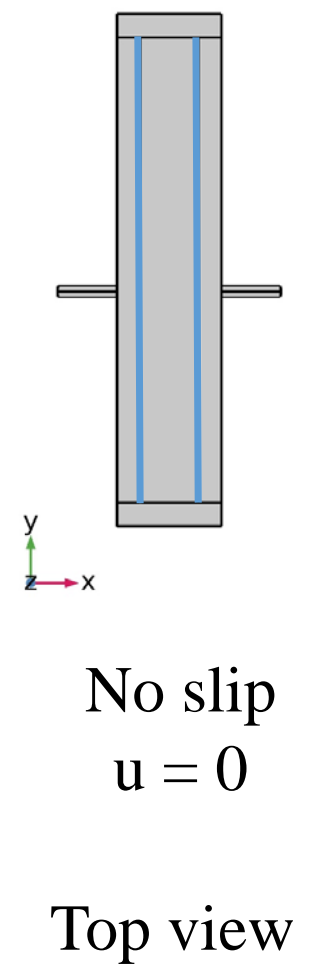
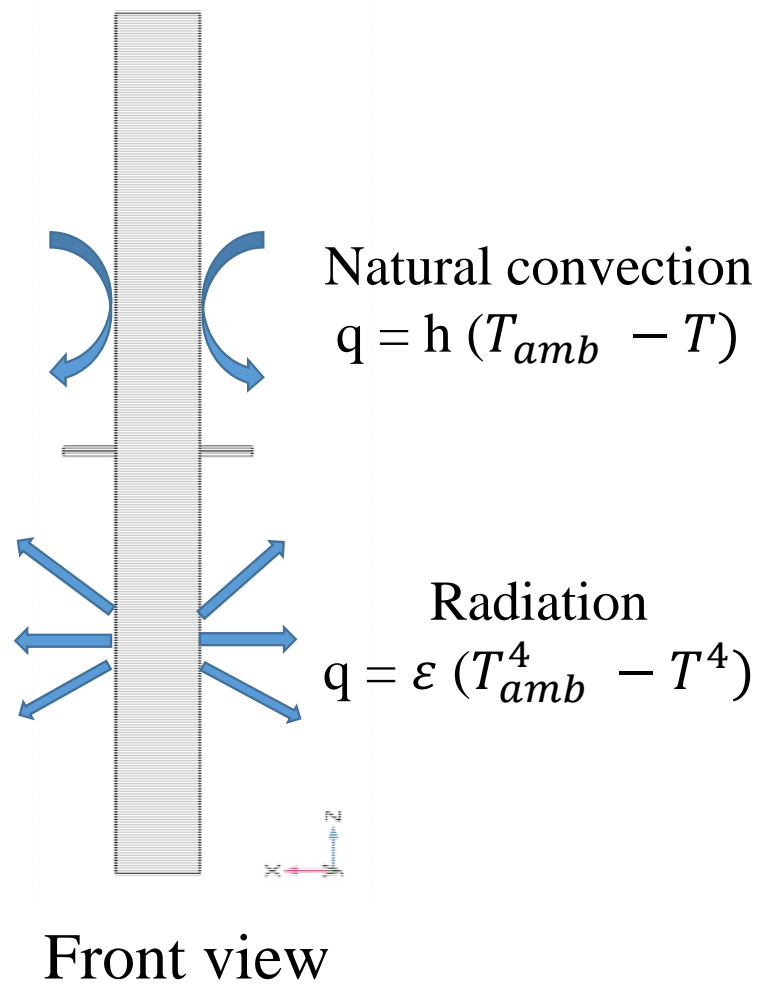
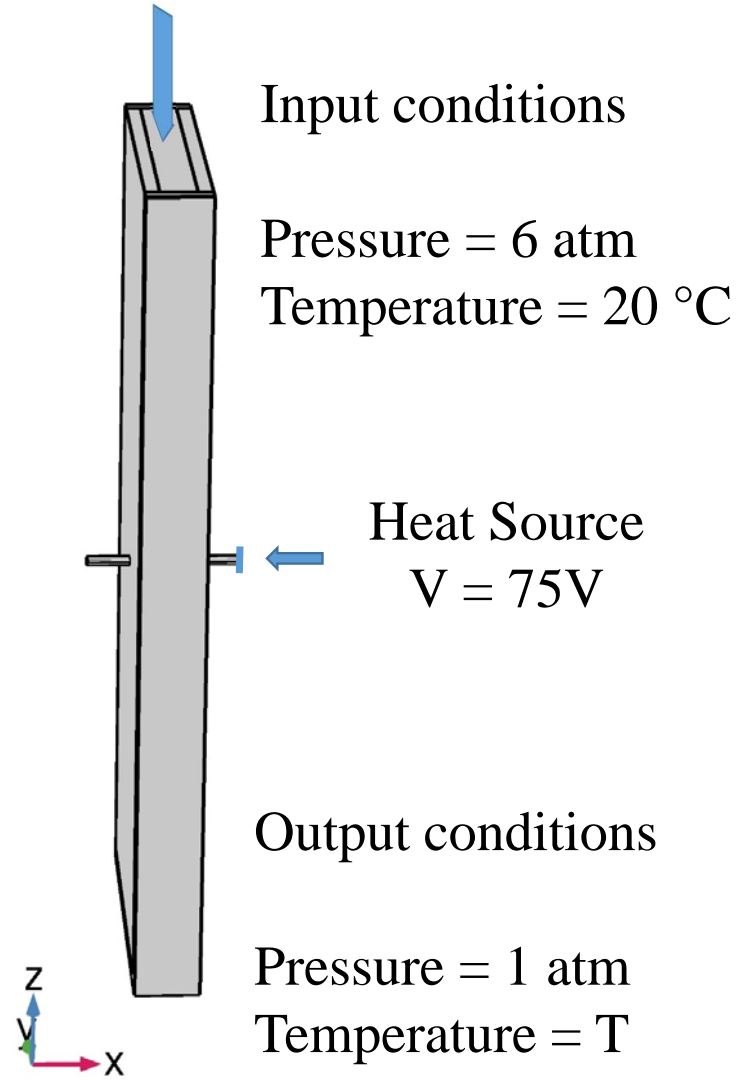


1. Laminar flow → Paste

2. Joule effect heating → Ohmic heating

Coupled with
3. Heat transfer in solids

Boundary conditions



Navier stockes

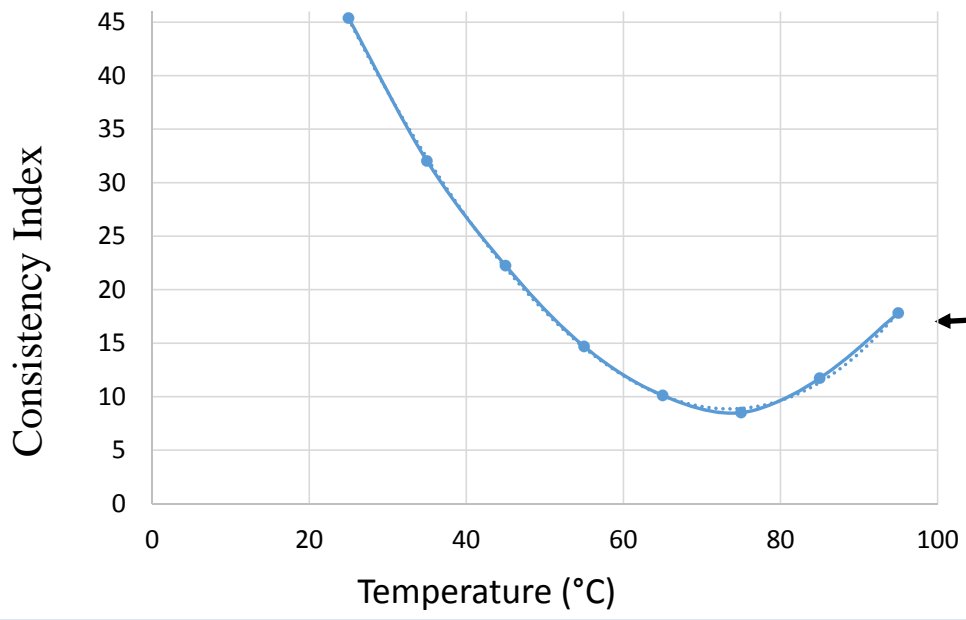
$$\rho \frac{\partial u}{\partial t} - \nabla \cdot \eta(\dot{\gamma}) (\nabla u + (\nabla u)^T) + \rho u \cdot \nabla u + \nabla p = 0$$

Dynamic Viscosity
Power law equation:

$$\eta = m \dot{\gamma}^{n-1}$$

Flow index
n = 0,624

Consistency Index (m)



Navier stockes

$$\rho \frac{\partial u}{\partial t} - \nabla \cdot \eta(\dot{\gamma}) (\nabla u + (\nabla u)^T) + \rho u \cdot \nabla u + \nabla p = 0$$

Dynamic Viscosity
Power law equation:

$$\eta = m \dot{\gamma}^{n-1}$$

Shear rate which is temperature dependant

➔ The model uses the shear rate calculated by COMSOL to determine the viscosity variation in function of temperature and shear rate.

Thermal diffusion equation

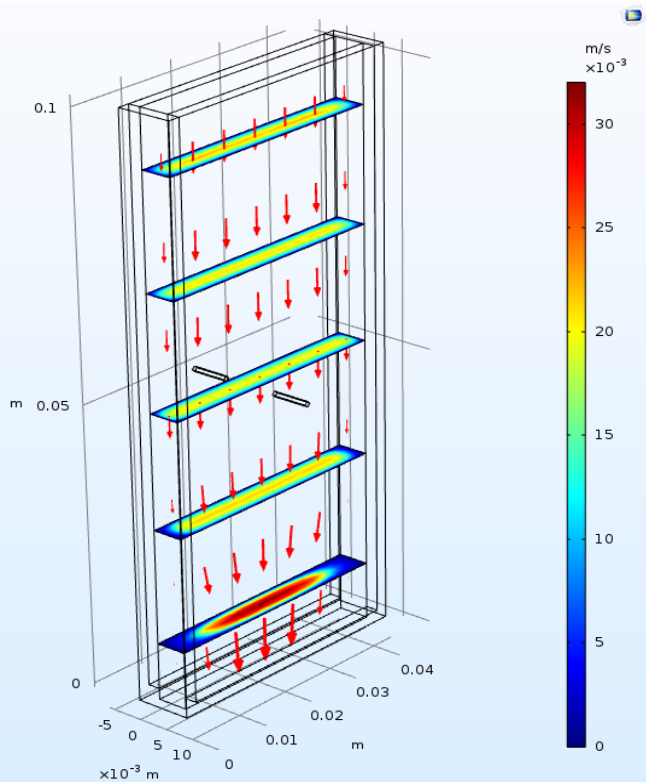
Heat transfer



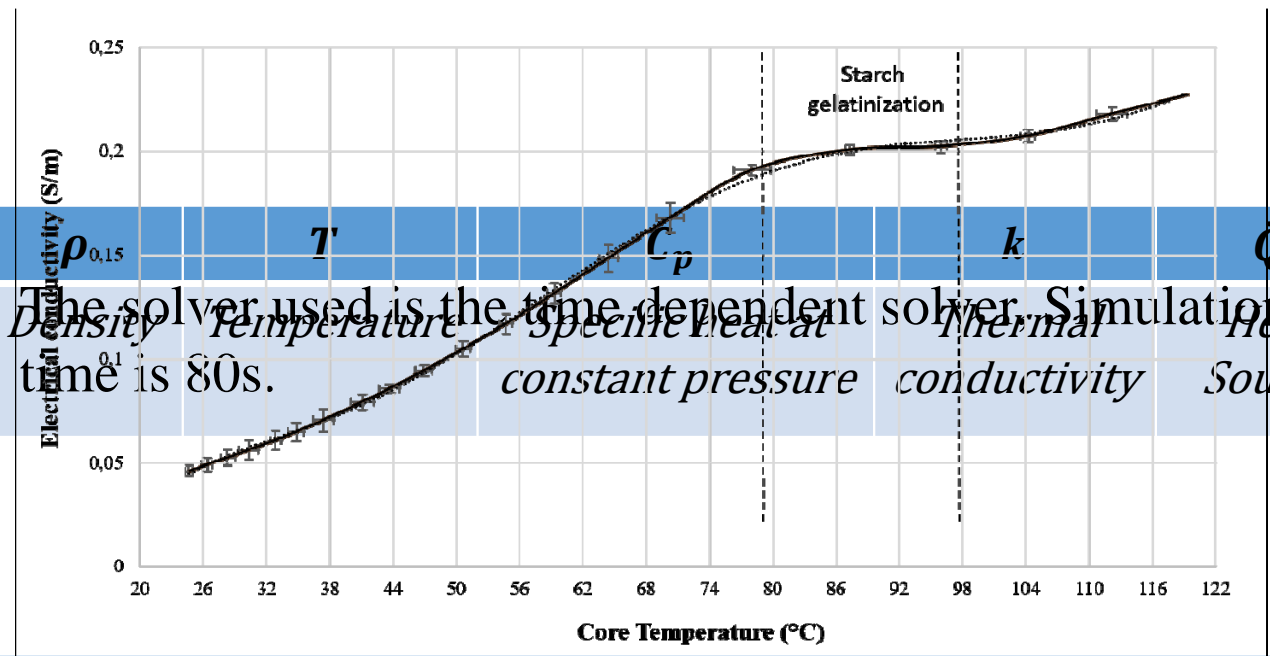
$$\rho C_p \frac{\partial T}{\partial t} + \rho C_p (\mathbf{u} \cdot \nabla) T = \nabla \cdot (k \nabla T) + \dot{Q}$$

Coupled with Joule effect

$$\dot{Q} = \sigma |E|^2$$



Navier stocks



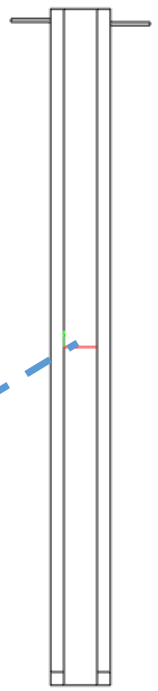
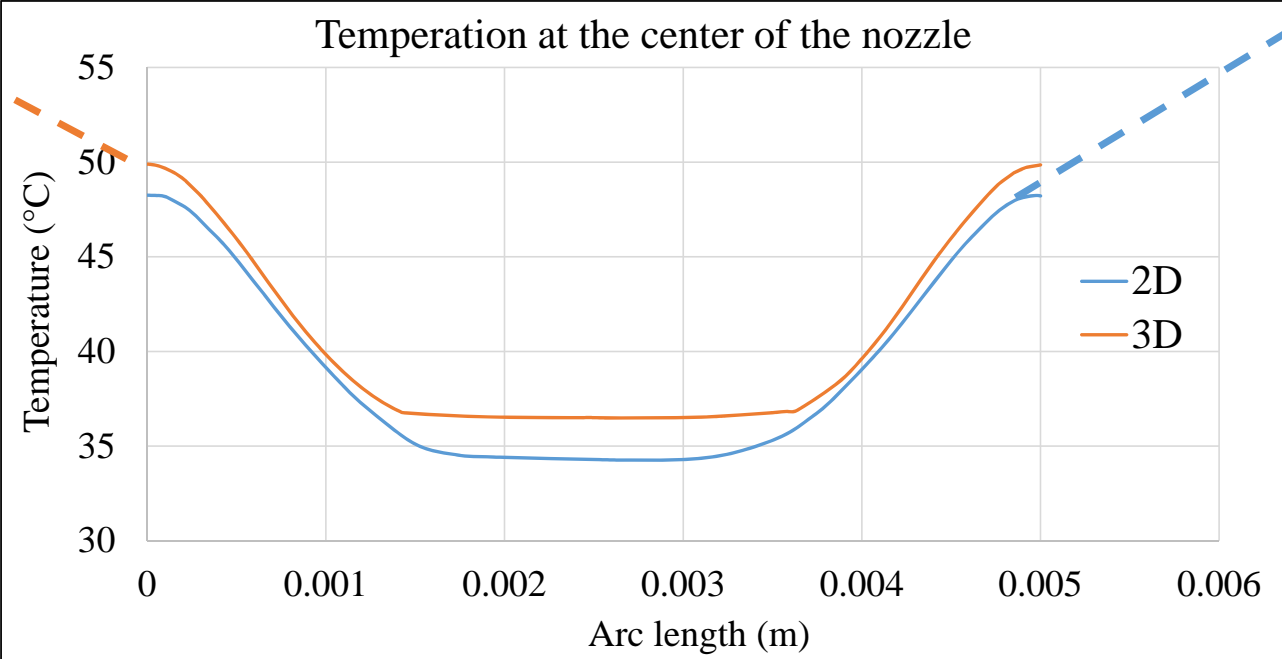
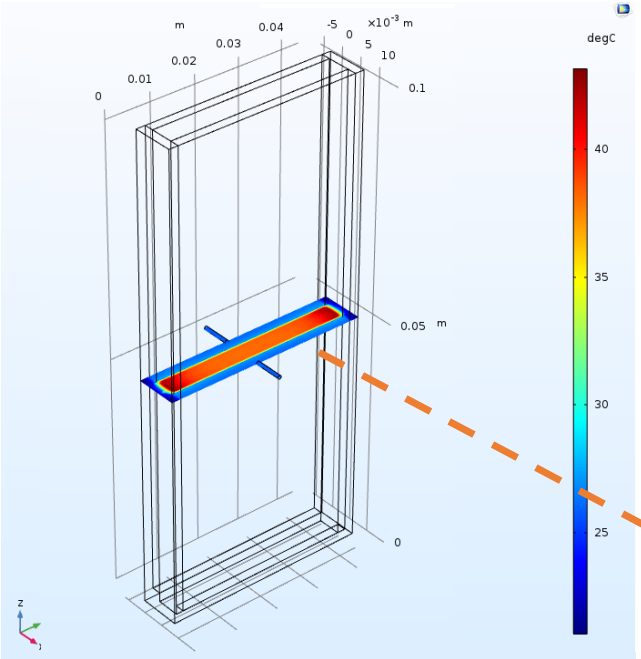
The solver used is the time dependent solver. Simulation time is 80s.

Parameters: ρ , C_p , k , \dot{Q}

Labels: Density, Temperature, Specific Heat at constant pressure, Thermal conductivity, Heat Source

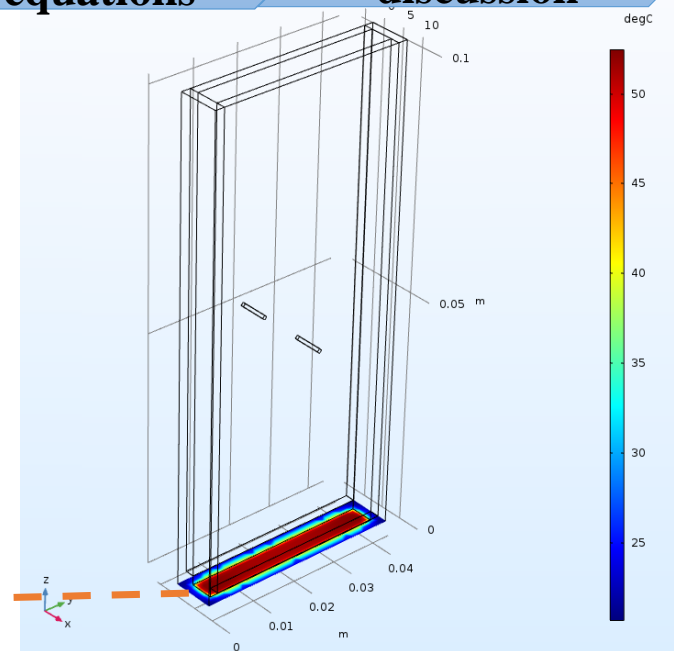
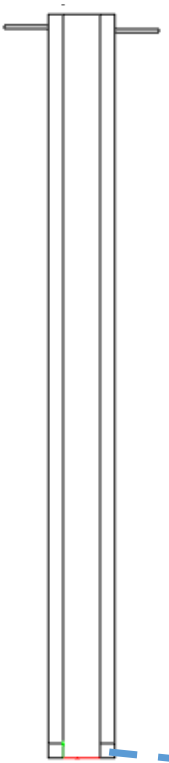
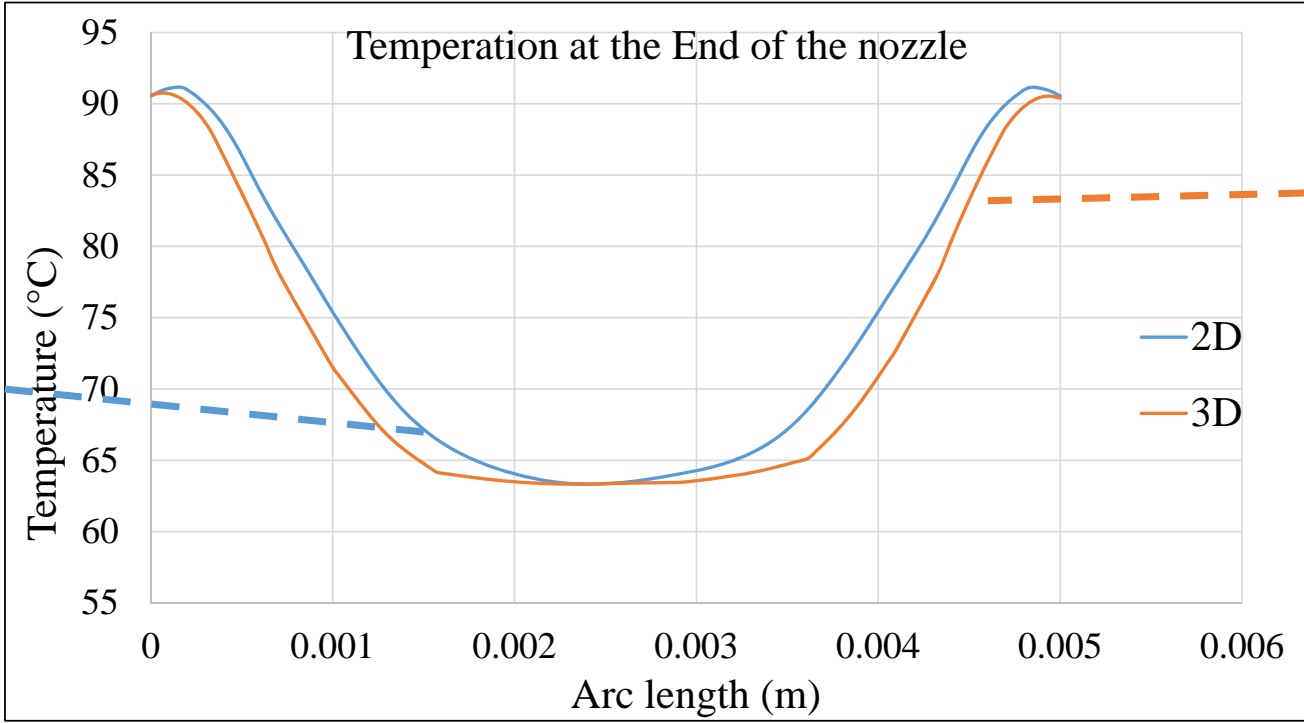
2D and 3D comparison

Temperature at the center
Difference $\approx 2^{\circ}\text{C}$



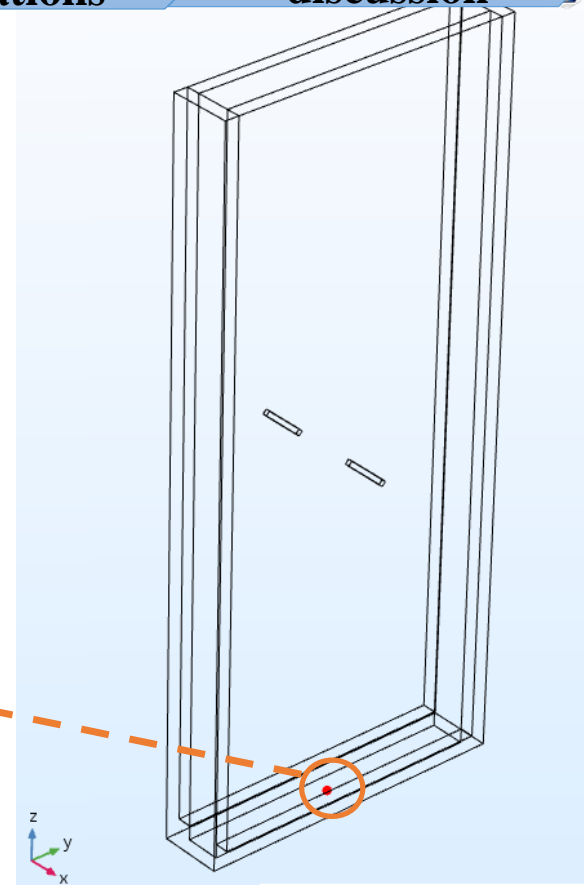
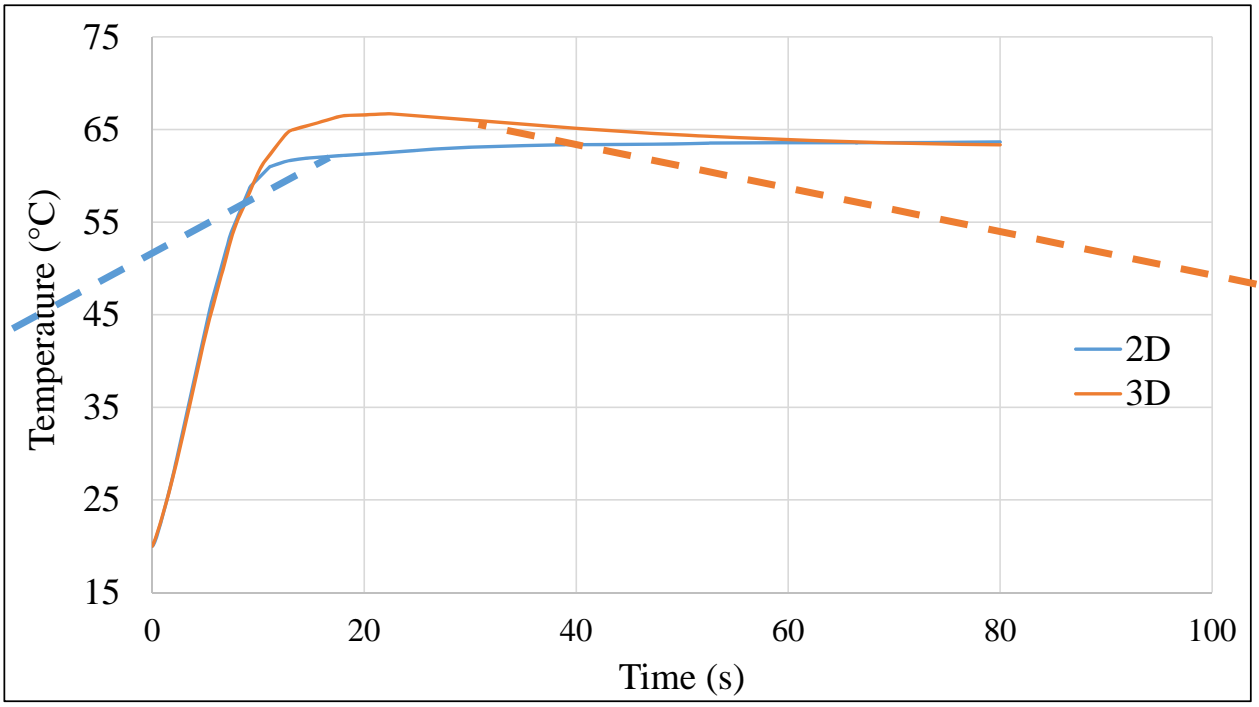
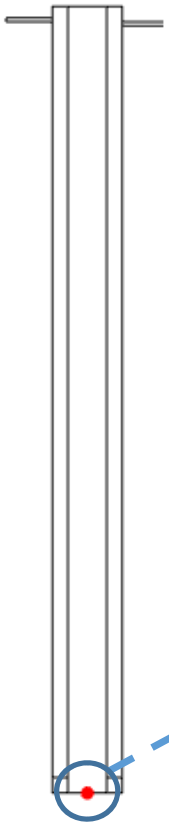
2D and 3D comparison

Temperature at the Output
Difference $\approx 1,5^{\circ}\text{C}$



2D and 3D comparison

Temperature on a point at the End of the nozzle



Parameter sweep

Afficher ← →

Label:

Données

Jeu de données:

Valeur des paramètres (largeur_electrodes (m)):

Temps (s):

Titre

Type de titre:

Réglages du graphique

Vue:

Afficher les entités cachées

Propagation du cache aux dimensions inférieures

Afficher les arêtes du jeu de données

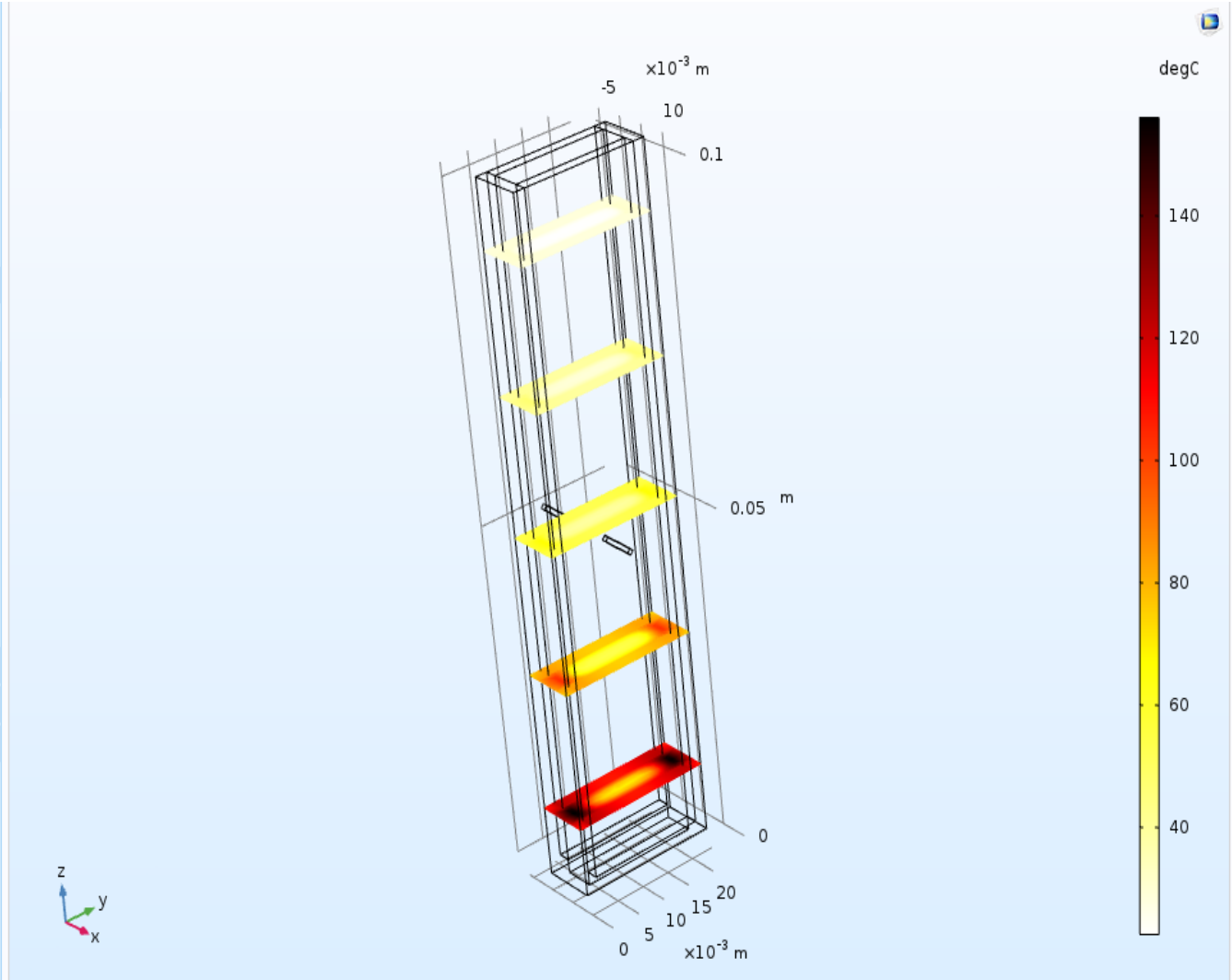
Couleur:

Référentiel:

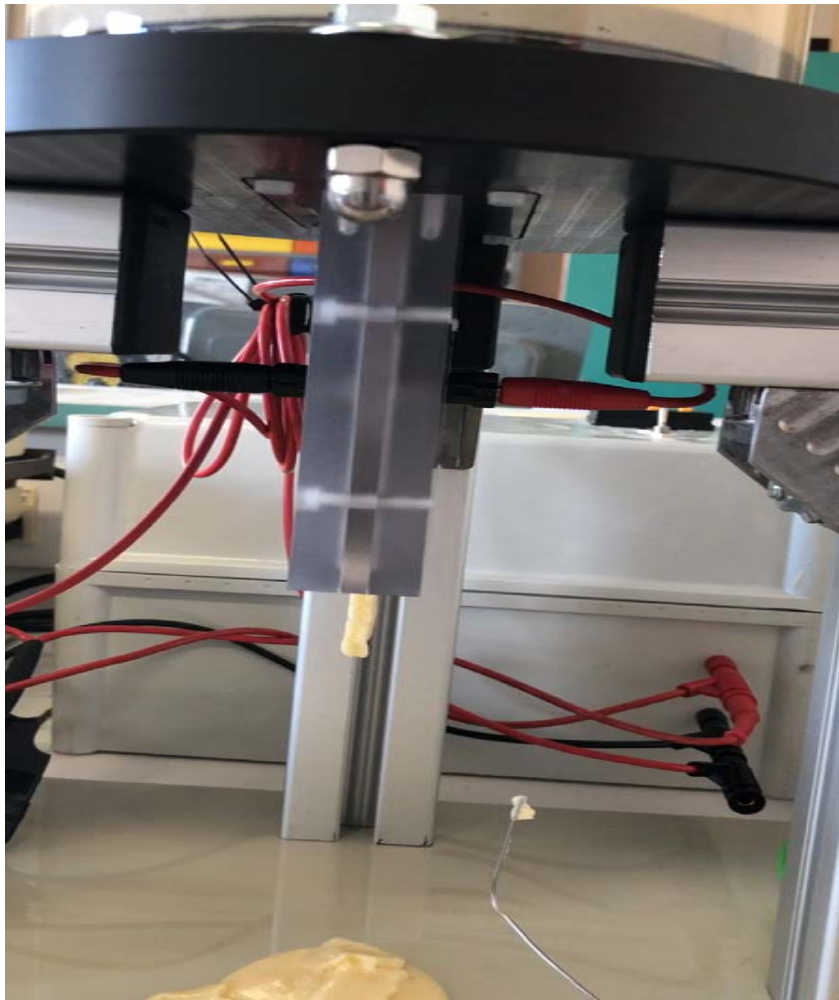
Légende de couleurs

Format de nombre

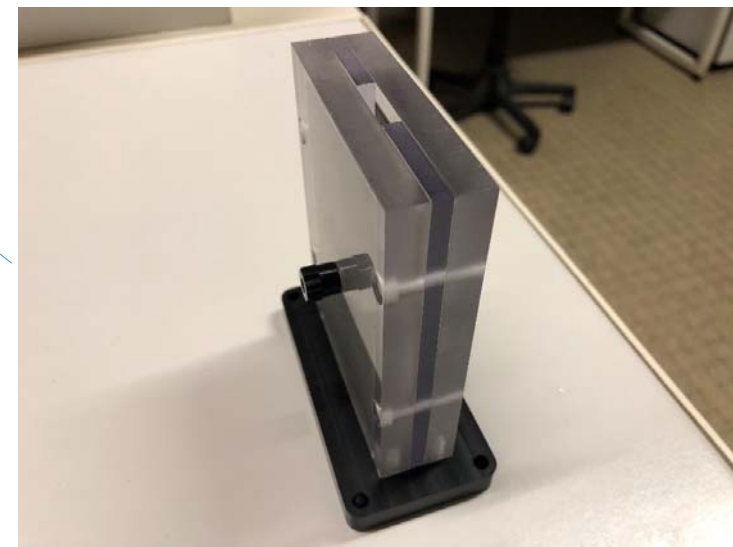
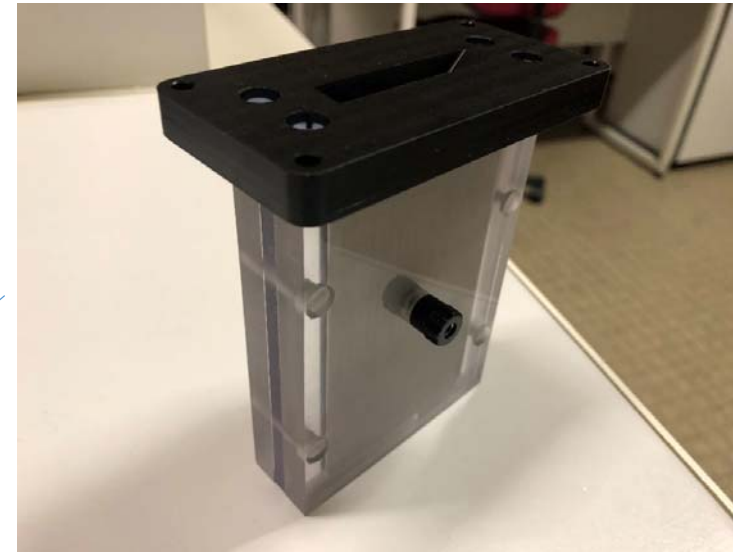
Réglages de la fenêtre graphique



Experimental set-up



3D Printer head
With Ohmic heating



Conclusion

1. Official Validation of the model
2. Modeling of the shear rate variation in our nozzle which is impossible experimentally
3. Optimization of our product by trying to reduce its dimension to fit for 3D printers

**THANK YOU FOR YOUR
ATTENTION**